

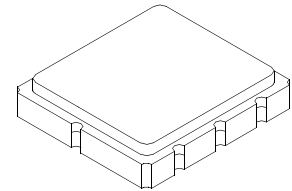
- *Designed for SDARS IF Receiver*
- *Low Insertion Loss*
- *5.0 x 5.0 mm Surface-mount Case*
- *Differential or Single-ended Input and Output*
- *Complies with Directive 2002/95/EC (RoHS)*
- *Moisture Sensitivity Level: 1*
- *AEC-Q200 Qualified*

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage on any Non-ground Terminal	30	VDC
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile	265°C for 10 s	

SF2038C

**76.500 MHz
SAW Filter**



SM5050-8

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_C			76.500		MHz
Passband Insertion Loss	IL			10.8	12.0	dB
1 dB Bandwidth	BW ₁		12.0	12.7		MHz
15 dB Bandwidth	BW ₁₅			17.5	18.0	MHz
30 dB Bandwidth	BW ₃₀			19.4	20.0	MHz
Amplitude Ripple over $f_C \pm 6.0$ MHz				0.60	1.3	dB _{P-P}
Group Delay Variation over $f_C \pm 6.0$ MHz	GDV			40	150	ns _{P-P}
Rejection:						dB
50 to 64.44 MHz			36	42		
64.44 to 66.70 MHz			33	39		
86.30 to 87.06 MHz			16*	24		
87.06 to 91.50 MHz			23*	34		
91.50 to 100.000 MHz			36	40		
Operating Temperature Range	T _A		-40		+85	°C
Frequency Temperature Coefficient	FTC			-87		ppm/°C
Differential Input				175 ohms		
Differential Output				180 ohms		
Case Style				SM5050-8 5 x 5 mm Nominal Footprint		
Lid Symbolization (Y=year, WW=week, S=shift)				913, <u>YWWS</u>		

*At low temperature extreme -40 °C

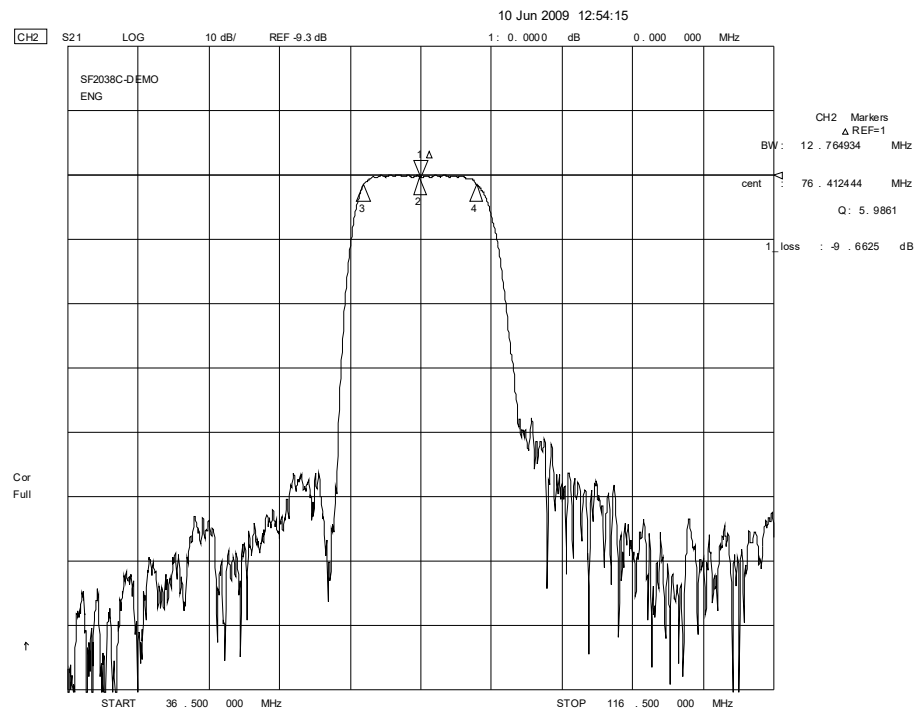


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

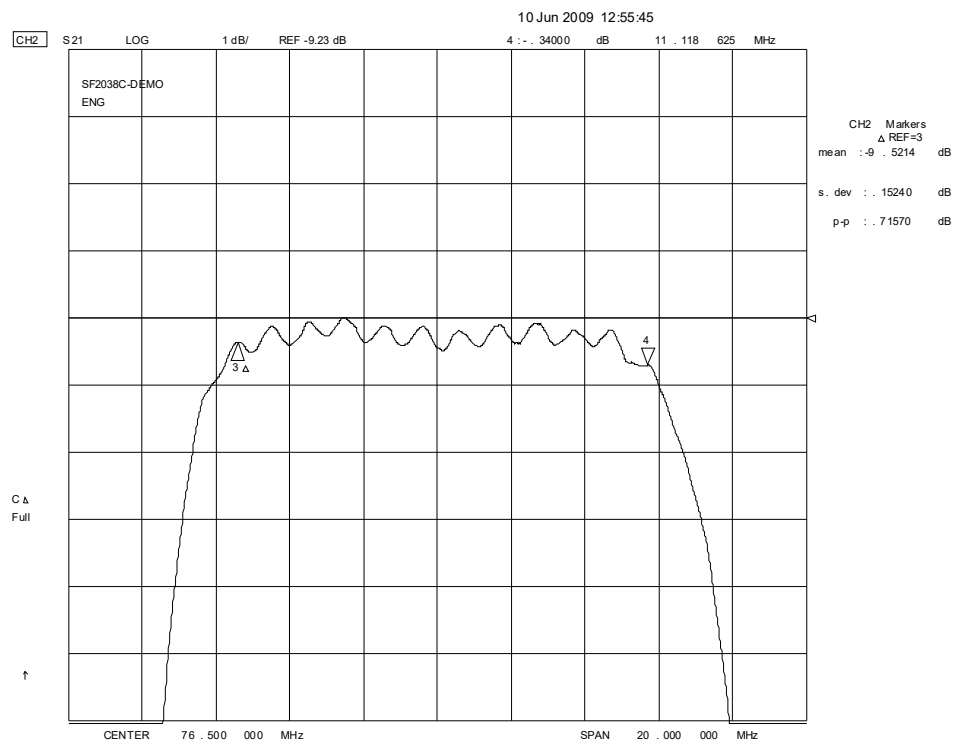
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

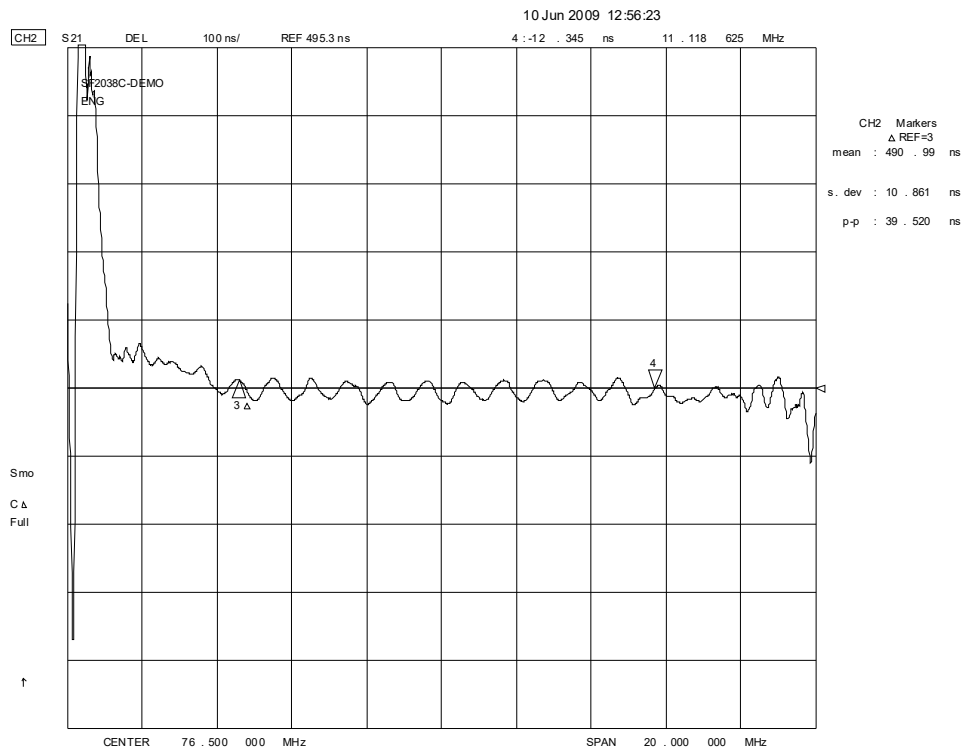
Filter Response, 36.5 to 116.5 MHz



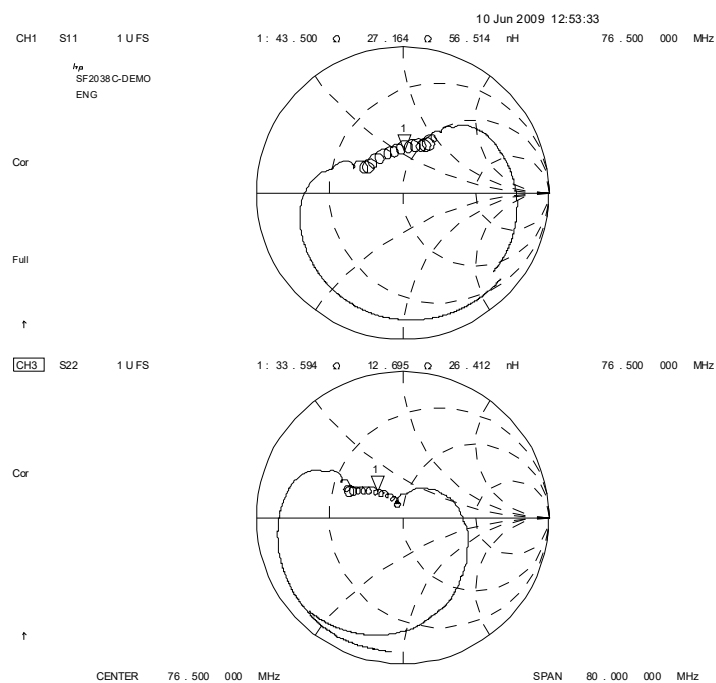
Filter Passband Response



Filter Passband Group Delay Response

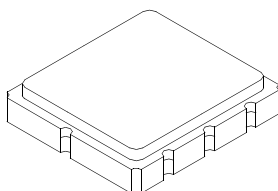


Filter S_{11} and S_{22} Plots

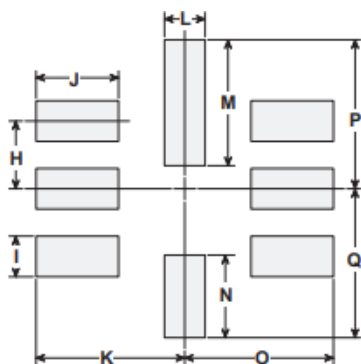


SM5050-8 Surface-Mount 8-Terminal Ceramic Case

5.0 X 5.0 mm Nominal Footprint



PCB Footprint



Case Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	4.80	5.00	5.20	0.189	0.197	0.205
B	4.80	5.00	5.20	0.189	0.197	0.205
C	1.30	1.50	1.70	0.050	0.060	0.067
D	1.98	2.08	2.18	0.078	0.082	0.086
E	1.07	1.17	1.27	0.042	0.046	0.050
F	0.50	0.64	0.70	0.020	0.025	0.028
G	2.39	2.54	2.69	0.094	0.100	0.106
H		1.27			0.050	
I		0.76			0.030	
J		1.55			0.061	
K		2.79			0.110	
L		0.76			0.030	
M		2.36			0.093	
N		1.55			0.061	
O		2.79			0.110	
P		2.79			0.110	
Q		2.79			0.110	

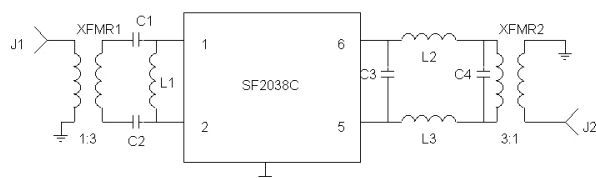
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel
Lid Plating	2.0 to 3.0 μ m Nickel
Body	Al ₂ O ₃ Ceramic

Electrical Connections

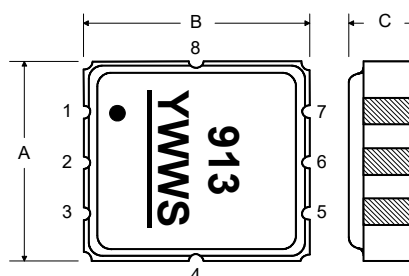
Connection		Terminals
Port 1	Differential Input	1, 2
Port 2	Differential Output	5, 6
	Ground	All others
Single-ended Operation		Return is ground
Differential Operation		Return is hot
Dot indicates Pin 1		

Test Circuit

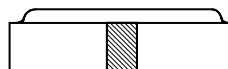
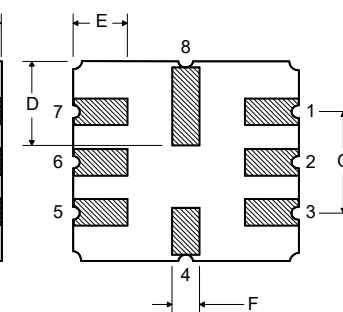


L1 330 nH
 L2, L3 270 nH
 C1, C4 18 pF
 C2 15 pF
 C3 1 pF
 XFMR1, XFMR 2 3:1
 XFMR1, XFMR 2 3:1

TOP VIEW

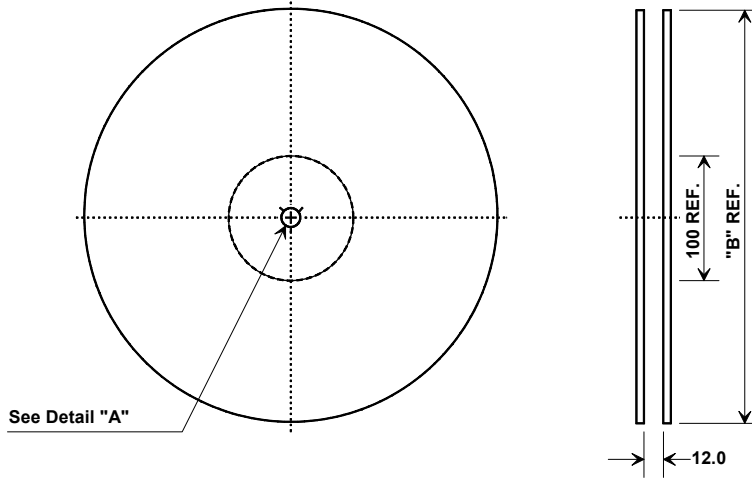


BOTTOM VIEW

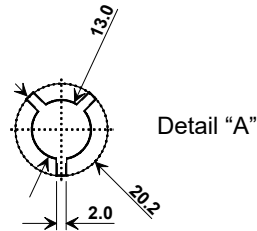


Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481

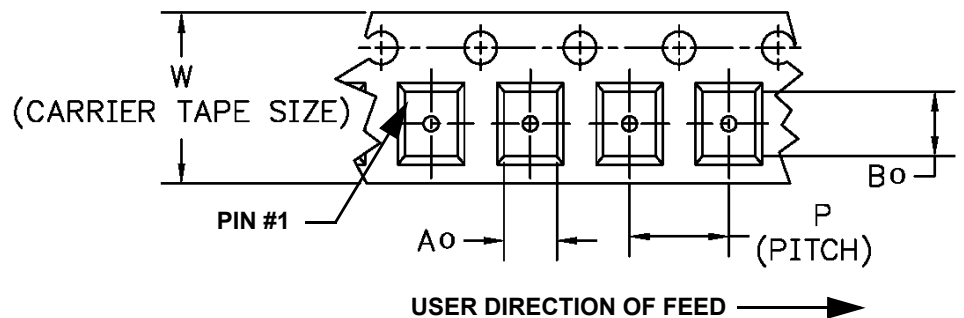
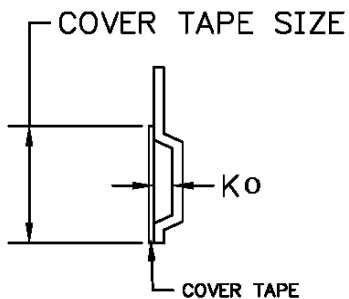


"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



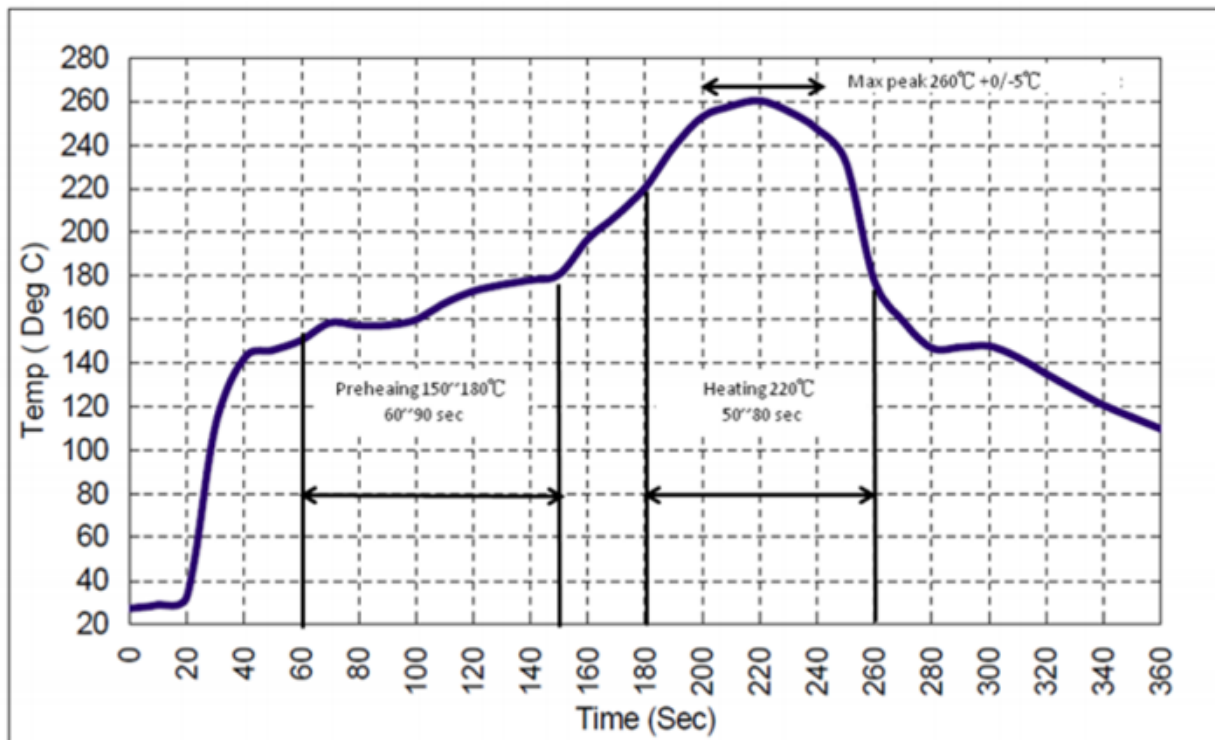
COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.3 mm
Bo	5.3 mm
Ko	2.0 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C+0/-5°C peak (10 seconds).
4. Time: 5 times maximum.



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